SN54HCT02, SN74HCT02 QUADRUPLE 2-INPUT POSITIVE-NOR GATES

SCLS065C - NOVEMBER 1988 - REVISED JUNE 2000

Inputs Are TTL-Voltage Compatible

 Package Options Include Plastic Small-Outline (D), Shrink Small-Outline (DB), and Ceramic Flat (W) Packages, Ceramic Chip Carriers (FK), and Standard Plastic (N) and Ceramic (J) DIPs

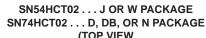
description

These devices contain four independent 2-input NOR gates. They perform the Boolean function $Y = \overline{A} \cdot \overline{B}$ or $Y = \overline{A} + \overline{B}$ in positive logic.

The SN54HCT02 is characterized for operation over the full military temperature range of -55° C to 125°C. The SN74HCT02 is characterized for operation from -40° C to 85° C.

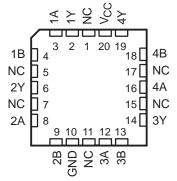
| FUNCTION TABLE (each gate) | | | | | | | | |
|-------------------------------|-----|--------|--|--|--|--|--|--|
| INP | UTS | OUTPUT | | | | | | |
| Α | В | Y | | | | | | |
| Н | Х | L | | | | | | |
| Х | Н | L | | | | | | |
| L | L | н | | | | | | |

logic symbol[†]

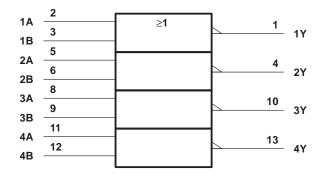


| | (101 | VIL VV | |
|---|-----------------------|----------|---|
| 1Y [1A [1B [2Y [2A [2B [GND] | 2 3 4 5 6 | 12 11 |] V _{CC}] 4Y] 4B] 4A] 3Y] 3B] 3A |
| | | | |

SN54HCT02 . . . FK PACKAGE (TOP VIEW)

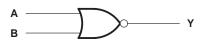


NC - No internal connection



[†] This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12. Pin numbers shown are for the D, DB, J, N, and W packages.

logic diagram, each gate (positive logic)





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absolute maximum ratings over operating free-air temperature range[†]

| Supply voltage range, V_{CC} Input clamp current, I_{IK} (V_I < 0 or V_I > V_{CC}) (see | ee Note 1) | ±20 mA |
|--|-------------|----------------|
| Output clamp current, I_{OK} (V _O < 0 or V _O > V _{CO} | | |
| Continuous output current, $I_O (V_O = 0 \text{ to } V_{CC})$ | | ±25 mA |
| Continuous current through V _{CC} or GND | | ±50 mA |
| Package thermal impedance, θ_{JA} (see Note 2): | : D package | 86°C/W |
| | DB package | 96°C/W |
| | N package | 80°C/W |
| Storage temperature range, T _{stg} | | –65°C to 150°C |

[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTES: 1. The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

2. The package thermal impedance is calculated in accordance with JESD 51.

recommended operating conditions (see Note 3)

| | | | SN | 154HCT02 | SN | N74HCT02 | 2 | UNIT |
|-----|---------------------------------------|---------------------------|------------|----------|-----|----------|-----|------|
| | | | MIN | NOM MAX | MIN | NOM | MAX | UNIT |
| Vcc | Supply voltage | | 4.5 | 5 🔥 5.5 | 4.5 | 5 | 5.5 | V |
| VIH | High-level input voltage | V_{CC} = 4.5 V to 5.5 V | 2 | N | 2 | | | V |
| VIL | Low-level input voltage | V_{CC} = 4.5 V to 5.5 V | 0 | 0.8 | 0 | | 0.8 | V |
| VI | Input voltage | | 0 | Vcc | 0 | | VCC | V |
| Vo | Output voltage | | 0 | S Vcc | 0 | | VCC | V |
| tt | Input transition (rise and fall) time | | <u>9</u> C | 500 | 0 | | 500 | ns |
| TA | Operating free-air temperature | | -55 | 125 | -40 | | 85 | °C |

NOTE 3: All unused inputs of the device must be held at V_{CC} or GND to ensure proper device operation. Refer to the TI application report, *Implications of Slow or Floating CMOS Inputs*, literature number SCBA004.

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

| PARAMETER | TEST CO | TEST CONDITIONS | | T _A = | | T _A = 25°C | | SN54HCT02 | | SN74HCT02 | |
|-----------|--|--------------------------|-------------------|------------------|-------|-----------------------|-----------|-----------|------|-----------|------|
| PARAMETER | TEST CO | NDITION5 | Vcc | MIN | TYP | MAX | MIN | MAX | MIN | MAX | UNIT |
| VOH | VI = VIH or VIL | I _{OH} = -20 μA | 4.5 V | 4.4 | 4.499 | | 4.4 | | 4.4 | | V |
| VOH | VI = VIH OL VIL | I _{OH} = -4 mA | 4.5 V | 3.98 | 4.3 | | 3.7 | ĥ | 3.84 | | v |
| Ve | $V_{I} = V_{IH} \text{ or } V_{IL}$ | I _{OL} = 20 μA | 4.5 V | | 0.001 | 0.1 | | 0.1 | | 0.1 | V |
| VOL | VI = VIH OI VIL | I _{OL} = 4 mA | 4.5 V | | 0.17 | 0.26 | | 0.4 | | 0.33 | v |
| li | VI = ACC or 0 | | 5.5 V | | ±0.1 | ±100 | 1 | ±1000 | | ±1000 | nA |
| ICC | $V_I = V_{CC} \text{ or } 0,$ | IO = 0 | 5.5 V | | | 2 | D_{n_c} | 40 | | 20 | μA |
| ∆ICC‡ | One input at 0.5 V Other inputs at 0 or | | 5.5 V | | 1.4 | 2.4 | 10yd | 3 | | 2.9 | mA |
| Ci | | | 4.5 V to 5.5 V | | 3 | 10 | | 10 | | 10 | pF |

[‡]This is the increase in supply current for each input that is at one of the specified TTL voltage levels rather than 0 V or V_{CC}.



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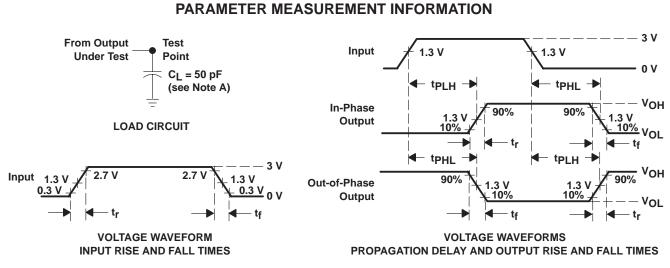
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switching characteristics over recommended operating free-air temperature range, $C_L = 50 \text{ pF}$ (unless otherwise noted) (see Figure 1)

| DADAMETED | PARAMETER FROM TO | | Vee | Т | λ = 25°C | ; | SN54HCT02 | SN74HCT02 | UNIT |
|------------|-------------------|-------------|-------|-----|----------|-----|-----------|-----------|------|
| FARAWETER | (INPUT) | Γ) (OUTPUT) | VCC | MIN | TYP | MAX | MIN MAX | MIN MAX | UNIT |
| 4 . | A or B | Y | 4.5 V | | 11 | 20 | 30 | 25 | 20 |
| τpd | | | 5.5 V | | 10 | 18 | 27 | 22 | ns |
| * . | | Y | 4.5 V | | 9 | 15 | 22 | 19 | 20 |
| чt | | | 5.5 V | | 8 | 14 | 20 | 17 | ns |

operating characteristics, T_A = 25°C

| | PARAMETER | TEST CONDITIONS | TYP | UNIT |
|-----------------|-------------------------------|-----------------|-----|------|
| C _{pd} | Power dissipation capacitance | No load | 20 | pF |



- NOTES: A. CL includes probe and test-fixture capacitance.
 - B. Phase relationships between waveforms were chosen arbitrarily. All input pulses are supplied by generators having the following characteristics: PRR \leq 1 MHz, Z_O = 50 Ω , t_f = 6 ns, t_f = 6 ns.
 - C. The outputs are measured one at a time with one input transition per measurement.
 - D. t_{PLH} and t_{PHL} are the same as t_{pd} .

Figure 1. Load Circuit and Voltage Waveforms



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